TOSHIBA Photocoupler IRED & Photo-MOSFET

TLP170D

PBX

Modem · Fax Card Telecommunication Security Equipment Measurement Equipment

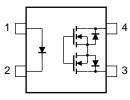
The Toshiba TLP170D consists of an infrared emitting diode optically coupled to a photo-MOSFET in a 4-pin SOP package.

This photorelay requires 1 mA of LED current to turn it on. It is suitable for applications that need electrical power saving.

- SOP 4 pin (2.54SOP4): 1-Form-A
- Peak off-state voltage: 200 V (min)
- Trigger LED current: 1 mA (max)
- ON-state current: 200 mA (max)
- ON-state resistance: 8 Ω (max)
- Isolation voltage: 1500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)

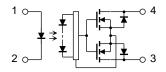
Note 1: When a VDE approved type is needed, please designate the **Option(V4)**.

Pin Configuration (top view)

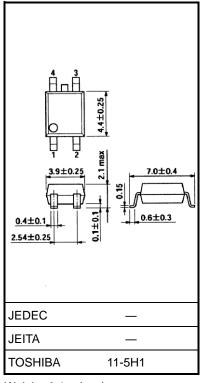


- 1: Anode
- 2: Cathode
- 3: Drain
- 4: Drain

Internal Circuit



Unit: mm



Weight: 0.1 g (typ.)

Start of commercial production 2009-06

Absolute Maximum Ratings (Ta = 25°C)

| | Characteristics | Symbol | Rating | Unit |
|-----------------------------------|---|----------------------|---------------|---------|
| | Forward current | l _F | 50 | mA |
| | Forward current derating (Ta ≥ 25°C) | ΔI _F /°C | -0.5 | mA/°C |
| | Pulse forward current (100 μs pulse, 100 pps) | IFP | 1 | А |
| LED | Reverse voltage | VR | 5 | V |
| | Diode power dissipation | PD | 50 | mW |
| | Diode power dissipation derating (Ta ≥25°C) | △P _D /°C | -0.5 | mW/°C |
| | Junction temperature | Tj | 125 | °C |
| | Off-state output terminal voltage | Voff | 200 | V |
| | On-state current | Ion | 200 | mA |
| Detector | On-state RMS current derating (Ta ≥ 25°C) | Δl _{ON} /°C | -2.0 | mA/°C |
| | Output power dissipation | Pc | 300 | mW |
| | Output power dissipation derating (Ta ≥ 25°C) | ΔP _C /°C | -3.0 | mW / °C |
| | Junction temperature | Tj | 125 | °C |
| Storage temperature range | | T _{stg} | −55 to 125 | °C |
| Operating temperature range | | Topr | -40 to 85 | °C |
| Lead soldering temperature (10 s) | | T _{sol} | 260 | °C |
| Isolation vo | oltage (AC, 60 s, R.H. ≤ 60 %) (Note 1) | BVs | 1500 | Vrms |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1:Device considered a two-terminal device: pins1 and 2 shorted together and pins 3 and 4 shorted together.

Recommended Operating Conditions

| Characteristics | Symbol | Min | Тур. | Max | Unit |
|-----------------------|------------------|-----|------|-----|------|
| Supply voltage | V_{DD} | _ | _ | 160 | V |
| Forward current | lF | _ | 2 | 25 | mA |
| ON-state current | Ion | _ | _ | 160 | mA |
| Operating temperature | T _{opr} | -20 | _ | 65 | °C |

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

| | Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|----------|-------------------|----------------|--------------------------|-----|------|------|------|
| LED | Forward voltage | VF | I _F = 10 mA | 1.0 | 1.15 | 1.3 | V |
| | Reverse current | I _R | V _R = 5 V | _ | _ | 10 | μА |
| | Capacitance | Ст | V = 0 V, f = 1 MHz | _ | 30 | _ | рF |
| Detector | OFF-state current | loff | V _{OFF} = 200 V | _ | 1 | 1000 | nA |
| | Capacitance | Coff | V = 0 V, f = 1 MHz | _ | 90 | _ | pF |

Coupled Electrical Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---------------------|--------|-------------------------|-----|------|-----|------|
| Trigger LED current | lfT | ION = 200 mA | _ | 0.4 | 1 | mA |
| Return LED current | IFC | IOFF = 100 μA | 0.1 | _ | _ | mA |
| On-state resistance | Ron | ION = 200 mA, IF = 2 mA | _ | 5 | 8 | Ω |

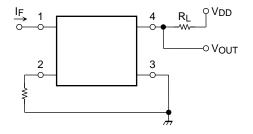
Isolation Characteristics (Ta = 25°C)

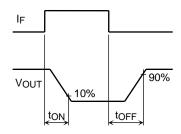
| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-----------------------------|--------|------------------------------------|----------------------|------------------|-----|------|
| Capacitance input to output | Cs | V _S = 0 V, f = 1 MHz | _ | 0.8 | _ | pF |
| Isolation resistance | Rs | V _S = 500 V, R.H. ≤ 60% | 5 × 10 ¹⁰ | 10 ¹⁴ | _ | Ω |
| Isolation voltage | BVS | AC, 60 s | 1500 | _ | _ | Vrms |

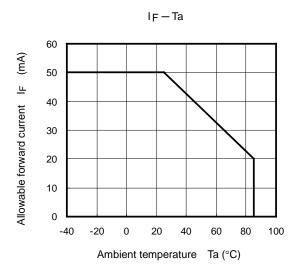
Switching Characteristics (Ta = 25°C)

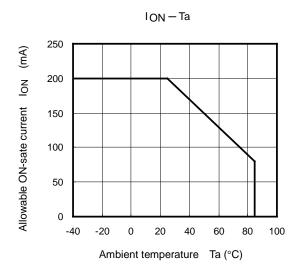
| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-----------------|--------|---|-----|------|-----|------|
| Turn-on time | ton | $\label{eq:RL} \begin{array}{l} \text{RL} = 200~\Omega \\ \text{V}_{\text{DD}} = 20~\text{V},~\text{IF} = 2~\text{mA} \end{array} \tag{Note2}$ | _ | 3.0 | 8.0 | ms |
| Turn-on time | ton | $\label{eq:RL} \begin{array}{l} \text{RL} = 200~\Omega \\ \text{V}_{\text{DD}} = 20~\text{V},~\text{IF} = 5~\text{mA} \end{array} \tag{Note2}$ | _ | _ | 5.0 | ms |
| Turn-off time | toff | $\label{eq:RL} \begin{split} \text{RL} &= 200 \ \Omega \\ \text{V}_{\text{DD}} &= 20 \ \text{V}, \ \text{IF} = 2 \ \text{mA} \end{split} \tag{Note2}$ | _ | 0.6 | 3.0 | ms |

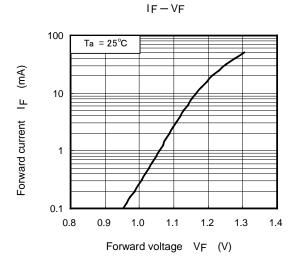
Note2: Switching time test circuit

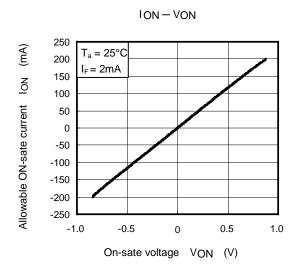


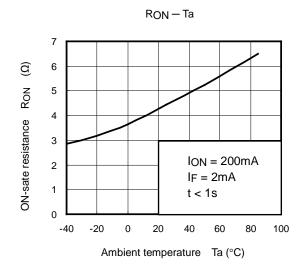


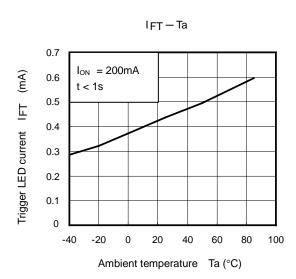




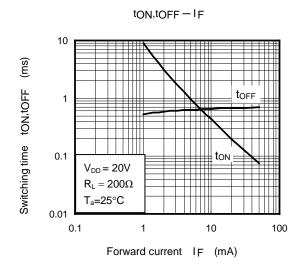


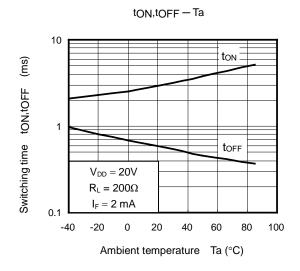


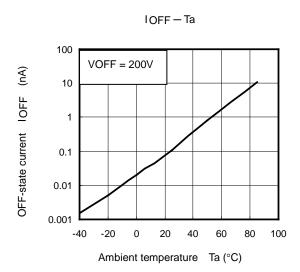




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.







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